

	Search Text	DBs
1	(((438/714,705,707,710,734).CCLS.) and @pd>="20040305")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
2	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo) and ((((438/714,705,707,710,734).CCLS.) and @pd>="20040305"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
3	(((438/714,705,707,710,734).CCLS.) and @pd>="20040730")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
4	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo) and S75	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
5	(etchrate etch near rate) with (metal indium near tin near oxide ito indium near zinc near oxide izo) and S75	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
6	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
7	(((438/714,705,707,710,734).CCLS.) and @pd>="20030620") and ((pre before treat\$4 prior) near3 etch\$5 with plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
8	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo) same (expos\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
9	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo) same (treat treatment) with plasma	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

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10	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast) with (metal indium near tin near oxide ito indium near zinc near oxide izo) same (treat treatment)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
11	(etchrate etch near rate) near2 (increas\$3 rais\$3 great\$3 faster fast)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
12	metal with plasma with ("H.sub.2") and ((438/714,705,707,710,734).CCLS.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
13	((438/714,705,707,710,734).CCLS.) and @pd>="20030220") and ((pre before treat\$4 prior) near3 etch\$5 with plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
14	((438/714,705,707,710,734).CCLS.) and @pd>="20020904") and ((pre before treat\$4 prior) near3 etch\$5 with plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
15	((438/714,705,707,710,734).CCLS.) and @pd>="20020503") and ((pre before treat\$4 prior) near3 etch\$5 with plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
16	("438"/\$ "257"/\$) and ((pre before treat\$4 prior) near3 etch\$5 with (hydrogen "H.sub.2") near2 plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
17	((438/714,705,707,710,734).CCLS.) and @pd>="20020503"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
18	(438/714,705,707,710,734).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
19	(438/714,705,707,710,734).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
20	treat\$3 with metal with plasma with ("H.sub.2")	USPAT
21	treat\$3 with ("H.sub.2") same (InSnO InZnO "In Sn O" "In Zn O") and ((438/714,705,707,710,734).CCLS.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
22	metal with plasma with ("H.sub.2") with ((438/714,705,707,710,734).CCLS.)	USPAT

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23	metal with plasma with ("H.sub.2") with ((438/714,705,707,710,734).CCLS.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
24	treat\$3 with metal with ("H.sub.2") same (InSnO InZnO "In Sn O" "In Zn O")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
25	(438/714,705,707,710,734).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
26	("438"/\$ "257"/\$) and ((pre before treat\$4 prior) near3 etch\$5 with (argon nitrogen hydrogen Ar "N.sub.2" "H.sub.2") near2 plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
27	(pre before treat\$4 prior) near3 etch\$5 with (hydrogen "H.sub.2") near2 plasma	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
28	(pre before treat\$4 prior) near3 etch\$5 with (argon nitrogen hydrogen Ar "N.sub.2" "H.sub.2") near2 plasma	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
29	((("438"/\$ "257"/\$) and ((pre before treat\$4 prior) near3 etch\$5 with (argon nitrogen hydrogen Ar "N.sub.2" "H.sub.2") near2 plasma)) not (((("438/714,705,707,710,734").CCLS.) and ((pre before treat\$4 prior) near3 etch\$5 with (argon nitrogen hydrogen Ar "N.sub.2" "H.sub.2") near2 plasma))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
30	((("438/714,705,707,710,734").CCLS.) and ((pre before treat\$4 prior) near3 etch\$5 with (argon nitrogen hydrogen Ar "N.sub.2" "H.sub.2") near2 plasma)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
31	(438/714,705,707,710,734).CCLS.	USPAT; USOCR
32	(ITO IZO) with (etch\$5 rie) and Hirano	EPO; JPO
33	"5723366"	EPO; JPO
34	(ITO IZO) near1 (etch\$5 rie)	EPO; JPO
35	(ITO IZO) with (etch\$5 rie) and Mohri	EPO; JPO
36	(ITO IZO) with (etch\$5 rie) and Tsou	EPO; JPO
37	ITO IZO)near3(etch\$5 rie	EPO; JPO
38	(ITO IZO) near3 (etch\$5 rie)	EPO; JPO
39	(ITO IZO) near2 (etch\$5 rie)	EPO; JPO

	Search Text	DBs
40	(ITO IZO) same (etch\$5 rie)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
41	(ITO IZO) same (etch\$5 rie)	EPO; JPO
42	(ITO IZO) with (etch\$5 rie)	EPO; JPO
43	(ITO IZO) and (etch\$5 plasma rie)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
44	(ITO IZO) and (etch\$5 rie)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
45	(HBr "H Br") with ("Cl.sub.2" and (HCl "H Cl")) same (etch\$5 rie plasma) same (Al Cu W tungsten aluminum copper tin Sn indium In (metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
46	((HBr "H Br") with ("CH.sub.4" "C H.sub.4") same (etch\$5 rie plasma) same (Al Cu W tungsten aluminum copper tin Sn indium In (metal))) and ((HBr "H Br") with ("Cl.sub.2" and (HCl "H Cl")) same (etch\$5 rie plasma) same (Al Cu W tungsten aluminum copper tin Sn indium In (metal)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
47	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") same (etch\$5 rie plasma) same (Al Cu W tungsten aluminum copper tin Sn indium In (metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
48	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") same (etch\$5 rie plasma) and ((metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
49	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") and ((metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
50	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") same ((metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
51	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") same ((indium adj zinc adj oxide indium adj tin adj oxide))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
52	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") and (ITO IZO)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB

	Search Text	DBs
53	(HBr "H Br") with ("CH.sub.4" "C H.sub.4") same (ITO IZO)	USPAT
54	(Mohri and "H.sub.2") and (ITO IZO)	USPAT
55	Mohri and "H.sub.2"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
56	(Mohri and "H.sub.2") and (Mohri and "H.sub.2")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
57	(Mohri and "H.sub.2") (Mohri and "H.sub.2")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
58	Mohri and "H.sub.2"	USPAT
59	(Mohri and "H.sub.2") and HBr	USPAT
60	("5286337").PN.	USPAT; USOCR
61	((("438/714").CCLS.) and (ITO IZO)	USPAT
62	((ITO IZO) and (HBr and "H.sub.2" and "Cl.sub.2") same (etch\$5 RIE)) not ((("438"/\$ and (liquid adj crystal adj display)) and (HBr and "H.sub.2"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
63	((ITO IZO) and (HBr and "H.sub.2") same (etch\$5 RIE)) not ((("438"/\$ and (liquid adj crystal adj display)) and (HBr and "H.sub.2"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
64	((ITO IZO) and (HBr and "H.sub.2") same (plasma etch\$5 RIE)) not ((("438"/\$ and (liquid adj crystal adj display)) and (HBr and "H.sub.2"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
65	treat\$3 with ("H.sub.2") same (InSnO InZnO "In Sn O" "In Zn O")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
66	treat\$3 with metal with ("H.sub.2") same (ITO IZO indium adj zinc adj oxide indium adj tin adj oxide)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
67	treat\$3 with metal with (plasma etch\$5 RIE) same (ITO IZO indium adj zinc adj oxide indium adj tin adj oxide)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
68	treat\$3 with metal with (plasma etch\$5 RIE)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
69	treat\$3 with metal with (plasma etch\$5 RIE) with ("H.sub.2")	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Search Text	DBs
70	treat\$3 with metal with (etch\$5 RIE) with ("H.sub.2")	USPAT
71	(treat\$3 with metal with (etch\$5 RIE) with ("H.sub.2")) not (treat\$3 with metal with plasma with ("H.sub.2"))	USPAT
72	treat\$3 near5 metal near5 plasma near5 ("H.sub.2")	USPAT
73	((indium adj oxide tin adj oxide) same (HBr and "H.sub.2")) not ((ITO IZO) same (HBr and "H.sub.2"))	USPAT
74	(indium adj oxide tin adj oxide) same (HBr and "H.sub.2")	USPAT
75	("438"/\$ and (liquid adj crystal adj display)) and (HBr and "H.sub.2")	USPAT
76	(ITO IZO) same (HBr and "H.sub.2")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
77	(ITO IZO) and (HBr and "H.sub.2") same (plasma etch\$5 RIE)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
78	(438/714).CCLS.	USPAT; USOCR
79	((((ITO IZO) and (HBr and "H.sub.2") same (plasma etch\$5 RIE)) not (("438"/\$ and (liquid adj crystal adj display)) and (HBr and "H.sub.2")))) not ((ITO IZO) same (HBr and "H.sub.2") same (plasma etch\$5 RIE))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
80	("5007982").PN.	USPAT; USOCR
81	(ITO IZO) same (HBr and "H.sub.2") same (plasma etch\$5 RIE)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
82	"438"/\$ and (liquid adj crystal adj display)	USPAT
83	"438"/\$ and (lcd lcds liquid adj crystal adj display)	USPAT